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07-16-2009

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office



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To the Director of the U.S. Patent and Trademark Office. Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies) Te-Yeu Su,
HSin-Herng Wang,
Ying-Ti Chu,
Chin-Ming Chu, and
Li-Chung Ping
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: Embed Technology Co., Ltd.
Internal Address: _____
Street Address: 5F, No. 66-11, Section 2,
Nankan Rd.
City: Lujhu Township,
State: Taoyuan County, 338
Country: Taiwan, (R.O.C.) Zip: _____
Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance/Execution Date(s):
Execution Date(s) 5/28/2009, 5/25/2009, 6/1/2009,
6/1/2009, 5/26/2009 respectively
 Assignment Merger
 Security Agreement Change of Name
 Joint Research Agreement
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other _____

4. Application or patent number(s): This document is being filed together with a new application.
A. Patent Application No.(s)
10/913,869
Additional numbers attached? Yes No

B. Patent No.(s)

5. Name and address to whom correspondence concerning document should be mailed:
Name: AMAD TAYEBI
Internal Address: _____
Street Address: 5 SEQUOIA RD
City: WESTFORD
State: MASSACHUSETTS Zip: 01886
Phone Number: (978) 692-7527
Fax Number: (978) 692-0197
Email Address: T1Westford@comcast.net

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

8. Payment Information
Deposit Account Number _____
Authorized User Name _____
07/15/2009 NJAMA1 00000006 10913869

9. Signature: C. Amad Tayebi
Signature
AMAD TAYEBI (Reg. # 46461)
Name of Person Signing

01 FC:8021 July 11, 2009 Date 40.00
Total number of pages including cover sheet, attachments, and documents: 6

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

ASSIGNMENT

I, Su, Te-Yeu, ("Assignor"), residing at 6F, No.52, Guosheng 2nd St., Taoyuan City, Taoyuan County 330, Taiwan (R.O.C.) am a coinventor and a coapplicant of invention titled "Polymer thick-film resistive paste, a polymer thick-film resistor and a method and a apparatus for the manufacture thereof" and described in U.S. Patent Application No. 913869, filed on August 7, 2004 and signed by me.

Embed Technology Co., Ltd., ("Assignee"), with offices located at 5F, No.66-11, Section 2, Nankan Rd. Lujhu Township, Taoyuan County, 338 Taiwan (R.O.C.), desires to acquire the entire and exclusive right, title and interest in and to the invention described in said Patent Application, in and to said Patent Application, in and to any continuation patent applications based on said Patent Application, and in and to all patents and reissues and/or extensions thereon, if any, that may be granted on said Patent Application.

Therefore, for good and valuable consideration, the receipt of which is hereby acknowledged, Assignor hereby assigns, grants and conveys, exclusively, to Assignee his entire right, title and interest in said invention, said Patent Application, all divisional, continuations in whole or in part and/or substitute applications based on said Patent Application and in and to all patents and reissues and/or extensions thereon, if any, that may be granted on said patent applications.

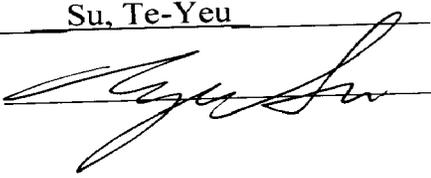
This assignment shall last for the entire term of any issued patent resulting from said Patent Application and any reissues or extensions that may be granted and for the entire terms of any and all foreign patents that may issue from foreign applications, as well as divisions, continuations in whole or in part or substitute applications filed claiming the benefit of said Patent Application.

Assignor hereby authorizes the United States Patent and Trademark Office to issue any patents claiming benefit from said Patent Application to Assignee. The entire right, title and interest is to be held and enjoyed by the Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor had this Assignment not been made.

Assignor further agrees to: (a) cooperate with Assignee in the prosecution of said Patent Application and foreign counterparts, (b) execute, verify, acknowledge and deliver all such further papers, including patent applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain the patent(s) for the invention in any and all countries.

Date: 05/28/2004

Assignor: Su, Te-Yeu

Signature: 

ASSIGNMENT

I, Wang, Hsin-herng, ("Assignor"), residing at 14F., No.134, Hongchang 8th St., Taoyuan City, Taoyuan County 330, Taiwan (R.O.C.) am a coinventor and a coapplicant of invention titled "Polymer thick-film resistive paste, a polymer thick-film resistor and a method and a apparatus for the manufacture thereof" and described in U.S. Patent Application No. 913869, filed on August 7, 2004 and signed by me.

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Date: May 25, 2009

Assignor: Wang, Hsin-herng

Signature: Wang, Hsin-herng

ASSIGNMENT

I, Chu, Ying-Ti, ("Assignor"), residing at No.3, Aly.22, Ln.16, Sec. 1, Zhongcheng Rd., Shilin Dist., Taipei City 111, Taiwan (R.O.C.) am a coinventor and a coapplicant of invention titled "Polymer thick-film resistive paste, a polymer thick-film resistor and a method and a apparatus for the manufacture thereof" and described in U.S. Patent Application No. 913869, filed on August 7, 2004 and signed by me.

Embed Technology Co., Ltd., ("Assignee"), with offices located at 5F, No.66-11, Section 2, Nankan Rd. Lujhu Township, Taoyuan County, 338 Taiwan (R.O.C.), desires to acquire the entire and exclusive right, title and interest in and to the invention described in said Patent Application, in and to said Patent Application, in and to any continuation patent applications based on said Patent Application, and in and to all patents and reissues and/or extensions thereon, if any, that may be granted on said Patent Application.

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Date: 06/01/2009

Assignor : Chu, Ying-Ti

Signature: Chu Ying-Ti

ASSIGNMENT

I, Chu, Chin-Ming, ("Assignor"), residing at No.3, Aly.22, Ln.16, Sec. 1, Zhongcheng Rd., Shilin Dist., Taipei City 111, Taiwan (R.O.C.) am a coinventor and a coapplicant of invention titled "Polymer thick-film resistive paste, a polymer thick-film resistor and a method and a apparatus for the manufacture thereof" and described in U.S. Patent Application No. 913869, filed on August 7, 2004 and signed by me.

Embed Technology Co., Ltd., ("Assignee"), with offices located at 5F, No.66-11, Section 2, Nankan Rd. Lujhu Township, Taoyuan County, 338 Taiwan (R.O.C.), desires to acquire the entire and exclusive right, title and interest in and to the invention described in said Patent Application, in and to said Patent Application, in and to any continuation patent applications based on said Patent Application, and in and to all patents and reissues and/or extensions thereon, if any, that may be granted on said Patent Application.

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Date: June 1, 2009 Assignor : Chu, Chin-Ming
 Signature: Chin ming chu

ASSIGNMENT

I, PING, LI-CHUNG ("Assignor"), residing at 10F., No.222, Fusing N. Rd., Jhongshan Dist., Taipei City 104, Taiwan (R.O.C.) am a coinventor and a coapplicant of invention titled "Polymer thick-film resistive paste, a polymer thick-film resistor and a method and a apparatus for the manufacture thereof" and described in U.S. Patent Application No. 913869, filed on August 7, 2004 and signed by me.

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Date: 05, 26, 2009

Assignor : PING, LI-CHUNG

Signature: 